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(74) **Agent: VIERING, JENTSCHURA & PARTNER LLP;**
P.O. Box 1088, Rochor Post Office, Rochor Road, Singa-
pore 911833 (SG).

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(71) **Applicant: RAZER (ASIA-PACIFIC) PTE. LTD.**
[SG/SG]; Razer SEA HQ, 1 one-north Crescent, #02-01,
Singapore 138538 (SG).

(72) **Inventors: CHENG, Chengyu;** c/o Razer (Asia-Pacific) Pte. Ltd., Razer SEA HQ, 1 one-north Crescent, #02-01, Singapore 138538 (SG). **WANG, Fumei;** c/o Razer (Asia-Pacific) Pte. Ltd., Razer SEA HQ, 1 one-north Crescent, #02-01, Singapore 138538 (SG). **HUNG, Yihsiang;** c/o Razer (Asia-Pacific) Pte. Ltd., Razer SEA HQ, 1 one-north Crescent, #02-01, SG 138538 (SG).

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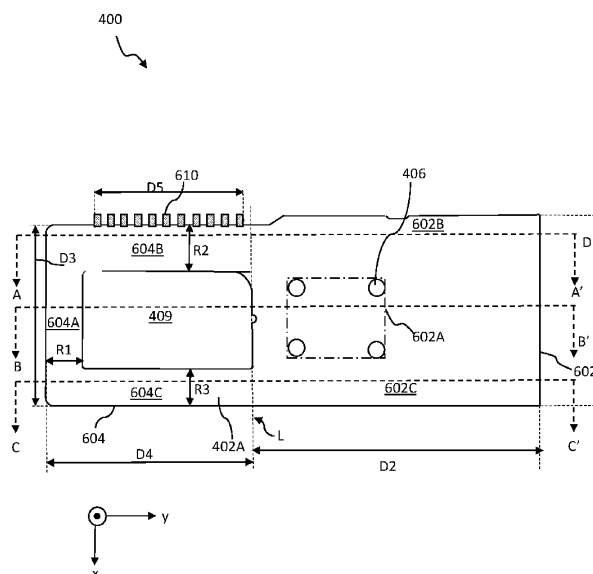


FIG. 5

(57) Abstract: In some aspects, a vapor chamber includes a sealed enclosure. The sealed enclosure includes: a main portion defining a main chamber and a duct portion. The main portion has a heat input surface region for contacting a heat source. The duct portion extends from a first margin region of the main portion and returns to a second margin region of the main portion. The heat input surface region is between the first margin region and the second margin region of the main portion. The main portion and the duct portion form a closed loop structure.

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